

Declaration and Power of Attorney For Patent Application

特許出願宣言書

Japanese Language Declaration

私は、下欄に氏名を記載した発明者として、以下のとおり宣言する：

私の住所、郵便の宛先および国籍は、下欄に氏名に続いて記載したとおりであり、

名称の発明に関し、請求の範囲に記載した特許を求める主題の本来の、最初にして唯一の発明者である（一人の氏名のみが下欄に記載されている場合）か、もしくは本来の、最初にして共同の発明者である（複数の氏名が下欄に記載されている場合）と信じ、

その明細書を
(該当する方に印を付す)

☐ ここに添付する。

☐ _____ 日に出願番号

第 _____ 号として提出し、

_____ 日に補正した。
(該当する場合)

私は、前記のとおり補正した請求の範囲を含む前記明細の内容を検討し、理解したことを陳述する。

私は、連邦規則法典第37部第1章第56条(a)項に従い、本願の審査に所要の情報を開示すべき義務を有することを認める。

As a below named inventor, I hereby declare that:

My residence, post office address and citizenship are as stated below next to my name,

I believe I am the original, first and sole inventor (if only one name is listed below) or an original, first and joint inventor (if plural names are listed below) of the subject matter which is claimed and for which a patent is sought on the invention entitled

"SEMICONDUCTOR INTEGRATED CIRCUIT
DEVICE"

the specification of which

(check one)

☒ is attached hereto.

☐ was filed on _____ as

Application Serial No. _____

and was amended on _____
(if applicable)

I hereby state that I have reviewed and understand the contents of the above identified specification, including the claims, as amended by any amendment referred to above.

I acknowledge the duty to disclose information which is material to the examination of this application in accordance with Title 37, Code of Federal Regulations, §1.56

Japanese Language Declaration

私は、合衆国法典第35部第119条にもとづく下記の外国特許出願または発明者証出願の外国優先権利益を主張し、さらに優先権の主張に係わる基礎出願の出願日前の出願日を有する外国特許出願または発明者証出願を以下に明記する：

I hereby claim foreign priority benefits under Title 35, United States Code, §119 of any foreign application(s) for patent or inventor's certificate listed below and have also identified below any foreign application for patent or inventor's certificate having a filing date before that of the application on which priority is claimed:

Prior foreign applications
先の外国出願

Priority claimed
優先権の主張

309024/97	Japan	11/11/1997
(Number) (番号)	(Country) (国名)	(Day/Month/Year Filed) (出願の年月日)
_____	_____	_____
(Number) (番号)	(Country) (国名)	(Day/Month/Year Filed) (出願の年月日)
_____	_____	_____
(Number) (番号)	(Country) (国名)	(Day/Month/Year Filed) (出願の年月日)
_____	_____	_____

<input checked="" type="checkbox"/> Yes あり	<input type="checkbox"/> No なし
<input type="checkbox"/> Yes あり	<input type="checkbox"/> No なし
<input type="checkbox"/> Yes あり	<input type="checkbox"/> No なし

私は、合衆国法典第35部第120条にもとづく下記の合衆国特許出願の利益を主張し、本願の請求の範囲各項に記載の主題が合衆国法典第35部第112条第1項に規定の様態で先の合衆国出願に開示されていない限度において、先の出願の出願日と本願の国内出願日またはPCT国際出願日の間に公表された連邦規則法典第37部第1章第56条(a)項に記載の所要の情報を開示すべき義務を有することを認める：

I hereby claim the benefit under Title 35, United States Code, §120 of any United States application(s) listed below and, insofar as the subject matter of each of the claims of this application is not disclosed in the prior United States application in the manner provided by the first paragraph of Title 35, United States Code, §112, I acknowledge the duty to disclose material information as defined in Title 37, Code of Federal Regulations, §1.56 which occurred between the filing date of the prior application and the national or PCT international filing date of this application:

(Application Serial No.) (出願番号)	(Filing Date) (出願日)
_____	_____
(Application Serial No.) (出願番号)	(Filing Date) (出願日)
_____	_____

(現況) (特許済み、係属中、放棄済み)	(Status) (patented, pending, abandoned)
_____	_____
(現況) (特許済み、係属中、放棄済み)	(Status) (patented, pending, abandoned)
_____	_____

私は、ここに自己の知識にもとづいて行った陳述がすべて真実であり、自己の有する情報および信ずるところに従って行った陳述が真実であると信じ、さらに故意に虚偽の陳述等を行った場合、合衆国法典第18部第1001条により、罰金もしくは禁錮に処せられるか、またはこれらの刑が併科され、またかかる故意による虚偽の陳述が本願ないし本願に対して付与される特許の有効性を損うことがあることを認識して、以上の陳述を行ったことを宣言する。

I hereby declare that all statements made herein of my own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issued thereon.

Japanese Language Declaration

委任状：私は、下記発明者として、以下の代理人をここに選任し、本願の手続を遂行すること並びにこれに関する一切の行為を特許商標庁に対して行うことを委任する。
(代理人氏名および登録番号を明記のこと)

POWER OF ATTORNEY: As a named inventor, I hereby appoint the following attorney(s) and/or agent(s) to prosecute this application and transact all business in the Patent and Trademark Office connected therewith. (list name and registration number)

William L. Mathis	17,337
Peter H. Smolka	15,913
Robert S. Swecker	19,885
Platon N. Mandros	22,124
Benton S. Duffett, Jr.	22,030
Joseph R. Magnone	24,239
Norman H. Stepno	22,716
Ronald L. Grudziecki	24,970
Frederick G. Michaud, Jr.	26,003
Alan E. Kopecki	25,813
Regis E. Sluter	26,999
Samuel C. Miller, III	27,360

Ralph L. Freeland, Jr.	16,110
Robert G. Mukai	28,531
George A. Hovanec, Jr.	28,223
James A. LaBarre	28,632
E. Joseph Gess	28,510
R. Danny Huntington	27,903
Eric H. Weisblatt	30,505
James W. Peterson	26,057
Teresa Stanek Rea	30,427
Robert E. Krebs	25,885
Robert M. Schulman	31,196

William C. Rowland	30,888
T. Gene Dillahunty	25,423
Anthony W. Shaw	30,104
Patrick C. Keane	32,858
Bruce J. Boggs, Jr.	32,344
William H. Benz	25,952
Peter K. Skiff	31,917
Richard J. McGrath	29,195
Mathew L. Schneider	32,814
Michael G. Savage	32,596
Gerald F. Swiss	30,113

書類の送付先：

Send Correspondence to:

Platon N. Mandros

BURNS, DOANE, SWECKER & MATHIS, L.L.P.
P.O. Box 1404
Alexandria, Virginia 22313-1404

直通電話連絡先：(名称および電話番号)

Direct Telephone Calls to: (name and telephone number)

Platon N. Mandros
703/836-6620

唯一のまたは第一の発明者の氏名	Full name of sole or first inventor Hiroshi Makino
同発明者の署名 日付	Inventor's signature Date Hiroshi Makino February 24, 1998
住所	Residence Tokyo, Japan
国籍	Citizenship Japan
郵便の宛先	Post Office Address c/o MITSUBISHI DENKI KABUSHIKI KAISHA, 2-3, Marunouchi 2-chome, Chiyoda-ku, Tokyo 100-8310 Japan
第2の共同発明者の氏名 (該当する場合)	Full name of second joint inventor, if any
同第2発明者の署名 日付	Second inventor's signature Date
住所	Residence
国籍	Citizenship
郵便の宛先	Post Office Address

(第6またはそれ以降の共同発明者に対しても同様な情報および署名を提供すること。)

(Supply similar information and signature for third and subsequent joint inventors.)

**ASSIGNMENT
(SOLE)****COPY**

THIS ASSIGNMENT, by Hiroshi Makino, residing at Tokyo, Japan
(hereinafter referred to as "the Assignor"), witnesseth:

WHEREAS, the Assignor has invented certain new and useful improvements in "SEMICONDUCTOR INTEGRATED CIRCUIT DEVICE" set forth in an application, [] which is a provisional application to be filed herewith; [X] which is a non-provisional application having an oath or declaration executed on even date herewith prior to filing of application; [] bearing Application No. _____, and filed on _____; and

WHEREAS, MITSUBISHI DENKI KABUSHIKI KAISHA, a corporation duly organized under and pursuant to the laws of Japan, and having its principal place of business at 2-3, Marunouchi 2-chome, Chiyoda-ku, Tokyo 100-8310 Japan (hereinafter referred to as "the Assignee"), is desirous of acquiring the entire right, title, and interest in and to said inventions, the right to file applications on said inventions and the entire right, title and interest in and to any applications, including provisional applications for Letters Patent of the United States or other countries claiming priority to said application, and in and to any Letters Patent or Patents, United States or foreign, to be obtained therefor and thereon.

NOW, THEREFORE, in consideration of One Dollar (\$1.00) and other good and sufficient consideration, the receipt of which is hereby acknowledged, the Assignor has sold, assigned, transferred, and set over, and by these presents does sell, assign, transfer, and set over, unto the Assignee, its successors, legal representatives, and assigns the entire right, title, and interest in and to the above-mentioned inventions, the right to file applications on said inventions and the entire right, title and interest in and to any applications for Letters Patent of the United States or other countries claiming priority to said application, and any and all Letters Patent or Patents of the United States of America and all foreign countries that may be granted therefor and thereon, and in and to any and all applications claiming priority to said applications, divisions, continuations, and continuations-in-part of said applications, and reissues and extensions of said Letters Patent or Patents, and all rights under the International Convention for the Protection of Industrial Property, the same to be held and enjoyed by the Assignee, for its own use and behalf and the use and behalf of its successors, legal representatives, and assigns, to the full end of the term or terms for which Letters Patent or Patents may be granted as fully and entirely as the same would have been held and enjoyed by the Assignor had this sale and assignment not been made;

AND for the same consideration, the Assignor hereby covenants and agrees to and with the Assignee, its successors, legal representatives, and assigns, that, at the time of execution and delivery of these presents, the Assignor is the sole and lawful owner of the entire right, title, and interest in and to the inventions set forth in said applications and said applications, including provisional applications, above-mentioned, and that the same are unencumbered, and that the Assignor has good and full right and lawful authority to sell and convey the same in the manner herein set forth;

AND for the same consideration, the Assignor hereby covenants and agrees to and with the Assignee, its successors, legal representatives, and assigns that the Assignor will, whenever counsel of the Assignee, or the counsel of its successors, legal representatives, and assigns, shall advise that any proceeding in connection with said inventions or said applications for Letters Patent or Patents, or any proceeding in connection with Letters Patent or Patents for said inventions in

any country, including interference proceedings, is lawful and desirable, or that any application claiming priority to said application, division, continuation, or continuation-in-part of any applications for Letters Patent or Patents, or any reissue or extension of any Letters Patent or Patents to be obtained thereon, is lawful and desirable, sign all papers and documents, take all lawful oaths, and do all acts necessary or required to be done for the procurement, maintenance, enforcement and defense of Letters Patent or Patents for said inventions, without charge to the Assignee, its successors, legal representatives, and assigns, but at the cost and expense of the Assignee, its successors, legal representatives, and assigns;

AND the Assignor hereby authorizes and requests the attorneys of BURNS, DOANE, SWECKER & MATHIS, LLP. of Alexandria, Virginia, to insert in the spaces provided above the filing date, application number, and attorney docket number of said application when known.

AND the Assignor hereby requests the Commissioner of Patents to issue any and all said Letters Patent of the United States to the Assignee, as the Assignee of said inventions and the Letters Patent to be issued thereon for the sole use and behalf of the Assignee, its successors, legal representatives, and assigns.

Date February 24, 1998 Name of Assignor Hiroshi Makino
Hiroshi Makino